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(54) **DISPLAY DEVICE AND MANUFACTURING METHOD THEREOF**

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**ABSTRACT**

(73) Assignee: **Japan Display Inc.**, Tokyo (JP)

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According to one embodiment, a manufacturing method of a display device includes forming a lower electrode, forming an insulating layer which covers the lower electrode, forming a partition which includes a lower portion located on the insulating layer and formed of a conductive material and an upper portion located on the lower portion and protruding from a side surface of the lower portion, forming an aperture which overlaps the lower electrode by patterning the insulating layer, forming an organic layer including a light emitting layer, on the lower electrode, and forming an upper electrode which covers the organic layer and is in contact with the lower portion of the partition. The insulating layer is formed of tetraethoxysilane (TEOS).

